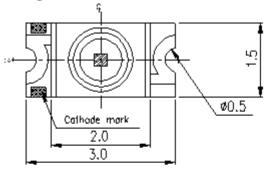
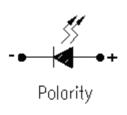
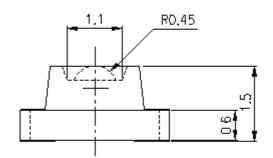


11-21UYC/S530-A3/TR8

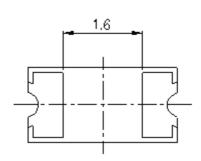
Package Outline Dimensions

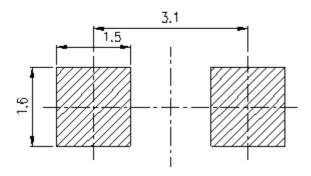






For reflow soldering (propose)





Notes: Tolerances Unless Dimension ± 0.1 mm, Unit = mm

Everlight Electronics Co., Ltd. Device No:SZDSE-111-011

http://www.everlight.com

Prepared date: 26-Jul-2007

Rev.1

Page: 2 of 9



11-21UYC/S530-A3/TR8

Absolute Maximum Ratings (Ta=25 $^{\circ}$ C)

Parameter	Symbol	Rating	Unit	
Reverse Voltage	VR	5	V	
Forward Current	IF	25	mA	
Peak Forward Current (Duty 1/10 @1KHz)	IFP	60	mA	
Power Dissipation	Pd	60	mW	
Electrostatic Discharge(HBM)	ESD	2000	V	
Operating Temperature	Topr	-40 ~ +85	$^{\circ}\!\mathbb{C}$	
Storage Temperature	Tstg	-40~ +90	$^{\circ}\!\mathbb{C}$	
Soldering Temperature	Tsol	Reflow Soldering : 260 °C for 10 sec. Hand Soldering : 350 °C for 3 sec.		

Electro-Optical Characteristics (Ta=25°C)

Parameter	Symbol	Min.	Тур.	Max.	Unit	Condition	
	-			1,1611			
Luminous Intensity	Iv	68	106		mcd		
Viewing Angle	2 \theta 1/2		60		deg		
Peak Wavelength	λр		591		nm		
Dominant Wavelength	λd		589		nm	I _F =20mA	
Spectrum Radiation Bandwidth	Δλ		15		nm		
Forward Voltage	V_{F}	1.7	2.0	2.4	V		
Reverse Current	I_R			10	μ A	$V_R=5V$	

Everlight Electronics Co., Ltd. Device No:SZDSE-111-011

http://www.everlight.com

Prepared date: 26-Jul-2007

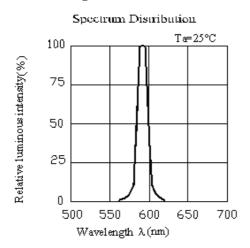
Rev.1

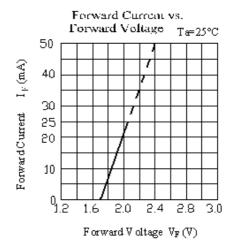
Page: 3 of 9

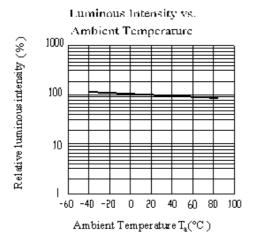


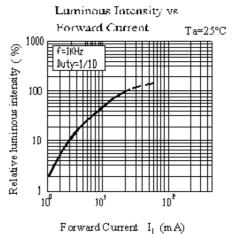
11-21UYC/S530-A3/TR8

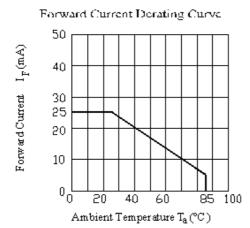
Typical Electro-Optical Characteristics Curves

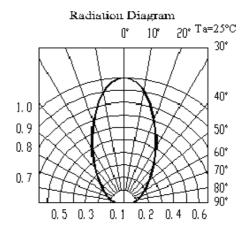












Everlight Electronics Co., Ltd. Device No:SZDSE-111-011

http://www.everlight.com

Prepared date: 26-Jul-2007

Rev.1

Page: 4 of 9



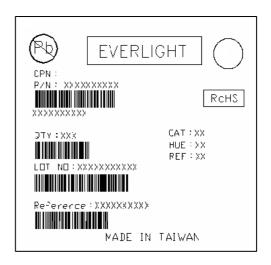
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Label explanation

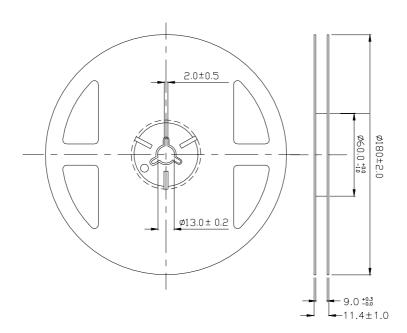
CAT: Luminous Intensity Rank

HUE: Dom. Wavelength Rank

REF: Forward Voltage Rank



Reel Dimensions



Note: The tolerances unless mentioned are ± 0.1 , Unit = mm.

Everlight Electronics Co., Ltd. Device No:SZDSE-111-011

http://www.everlight.com

Rev.1

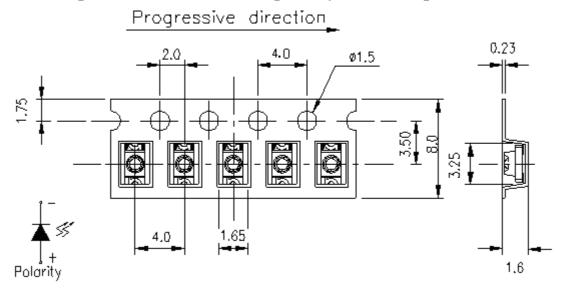
Page: 5 of 9

Prepared date: 26-Jul-2007



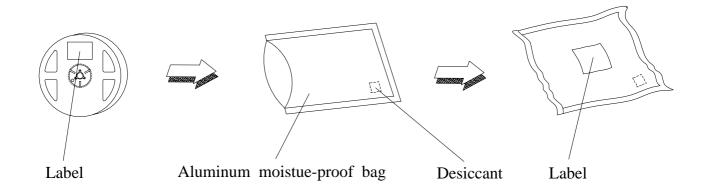
11-21UYC/S530-A3/TR8

Carrier Tape Dimensions: Loaded quantity 2000 PCS per reel



Note: The tolerances unless mentioned are ± 0.1 , Unit = mm.

Moisture Resistant Packaging



Everlight Electronics Co., Ltd. Device No:SZDSE-111-011

http://www.everlight.com

Prepared date: 26-Jul-2007

Rev.1 Page: 6 of 9



11-21UYC/S530-A3 /TR8

Reliability Test Items And Conditions

The reliability of products shall be satisfied with items listed below.

Confidence level: 90 %

LTPD: 10 %

No.	Items	Test Condition	Test Hours/Cycles	Sample Size	Ac/Rc
1	Reflow	Temp. : 260°C±5°C Min. 5 sec.	6 min.	22 Pcs.	0/1
2	Temperature Cycle	H:+85°C 30min. ∫ 5 min. L:-55°C 30min.	50 Cycles	22 Pcs.	0/1
3	Thermal Shock	H:+100°C 5min. ∫ 10 sec. L:-10°C 5min.	50 Cycles	22 Pcs.	0/1
4	High Temperature Storage	Temp. : 100°C	1000 Hrs.	22 Pcs.	0/1
5	Low Temperature Storage	Temp. : -55°€	1000 Hrs.	22 Pcs.	0/1
6	DC Operating Life	$I_F = 20 \text{ mA}$	1000 Hrs.	22 Pcs.	0/1
7	High Temperature / High Humidity	85°C/85% R.H	1000 Hrs.	22 Pcs.	0/1

Everlight Electronics Co., Ltd. Device No:SZDSE-111-011

http://www.everlight.com

Prepared date: 26-Jul-2007

Rev.1

Page: 7 of 9



11-21UYC/S530-A3 /TR8

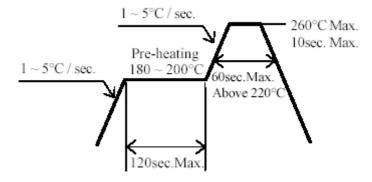
Precautions For Use

1. Over-current-proof

Customer must apply resistors for protection, otherwise slight voltage shift will cause big current change (Burn out will happen).

- 2. Storage
 - 2.1 Do not open moisture proof bag before the products are ready to use.
- 2.2 Before opening the package: The LEDs should be kept at 30°C or less and 90%RH or less.
- 2.3 After opening the package: The LED's floor life is 1 year under 30°C or less and 60% RH or less. If unused LEDs remain, it should be stored in moisture proof packages.
- 2.4 If the moisture absorbent material (silica gel) has faded away or the LEDs have exceeded the storage time, baking treatment should be performed using the following conditions.

 Baking treatment: 60±5°C for 24 hours.
- 3. Soldering Condition
 - 3.1 Pb-free solder temperature profile



- 3.2 Reflow soldering should not be done more than two times.
- 3.3 When soldering, do not put stress on the LEDs during heating.
- 3.4 After soldering, do not warp the circuit board.

Everlight Electronics Co., Ltd. Device No:SZDSE-111-011

http://www.everlight.com

Rev.1

Page: 8 of 9

Prepared date: 26-Jul-2007



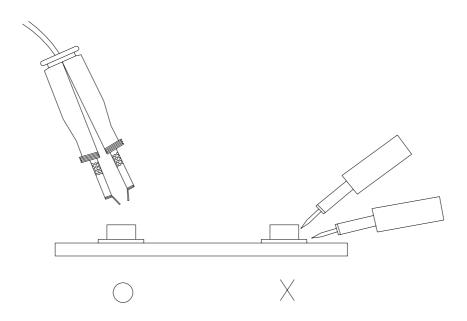
11-21UYC/S530-A3 /TR8

4. Soldering Iron

Each terminal is to go to the tip of soldering iron temperature less than 350°C for 3 seconds within once in less than the soldering iron capacity 25W. Leave two seconds and more intervals, and do soldering of each terminal. Be careful because the damage of the product is often started at the time of the hand solder.

5.Repairing

Repair should not be done after the LEDs have been soldered. When repairing is unavoidable, a double-head soldering iron should be used (as below figure). It should be confirmed beforehand whether the characteristics of the LEDs will or will not be damaged by repairing.



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Everlight Electronics Co., Ltd.

Device No:SZDSE-111-011

http://www.everlight.com

Rev.1

Page: 9 of 9

Prepared date: 26-Jul-2007